

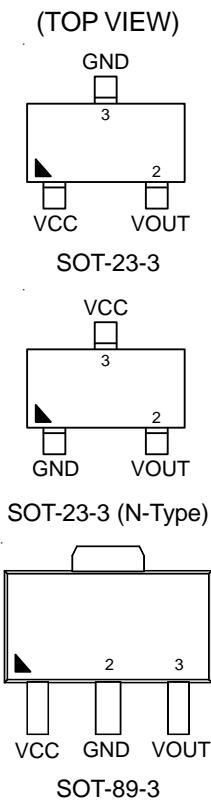
1 μ A I_Q, 250mA Low-Dropout Linear Regulator

General Description

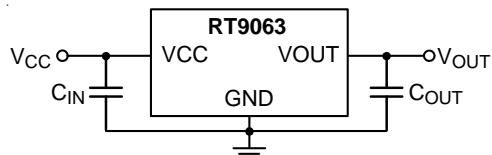
The RT9063 is a low-dropout (LDO) linear regulator that features high input voltage, low dropout voltage, ultra-low operating current, and miniaturized packaging. With quiescent current as low as 1 μ A, the RT9063 is ideal for battery-powered equipment.

The RT9063's stability requirements are easily met with all types of output capacitors, including tiny ceramic capacitors, over its wide input range and its load current range (0mA to 250mA). The RT9063 offers standard output voltages of 1.2V, 1.5V, 1.8V, 2.5V and 3.3V.

Pin Configurations



Simplified Application Circuit



Features

- 1 μ A Quiescent Current
- $\pm 2\%$ Output Accuracy
- 250mA Output Current
- Dropout Voltage : 0.4V at 200mA
- Fixed Output Voltage 1.2V/1.5V/1.8V/2.5V/3.3V
- Stable with Ceramic or Tantalum Capacitor
- Current Limit Protection
- Over-Temperature Protection
- SOT-23-3, SOT-89-3 Packages
- RoHS Compliant and Halogen Free

Applications

- Portable, Battery Powered Equipment
- Ultra Low Power Microcontrollers

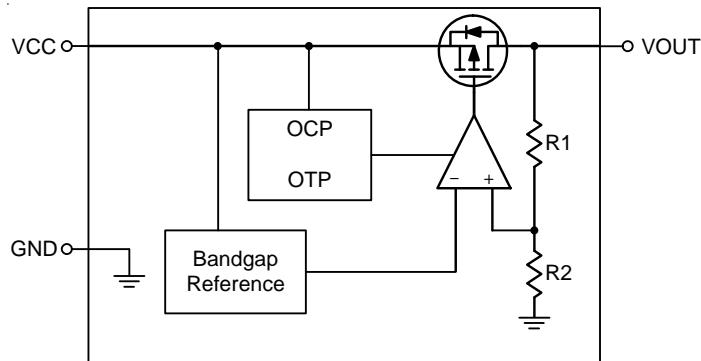
Ordering and Marking Information

Part Number	Output Voltage	Package	Marking Information
RT9063-12GV	1.2V	SOT-23-3	0G=
RT9063-12GVN		SOT-23-3 (N)	2T=
RT9063-12GX		SOT-89-3	07=
RT9063-15GV	1.5V	SOT-23-3	2M=
RT9063-15GVN		SOT-23-3 (N)	2U=
RT9063-18GV		SOT-23-3	0H=
RT9063-18GVN	1.8V	SOT-23-3 (N)	2V=
RT9063-18GX		SOT-89-3	08=
RT9063-23GV	2.3V	SOT-23-3	47=
RT9063-23GVN		SOT-23-3 (N)	42=
RT9063-25GV	2.5V	SOT-23-3	0J=
RT9063-25GVN		SOT-23-3 (N)	2W=
RT9063-25GX		SOT-89-3	09=
RT9063-27GV	2.7V	SOT-23-3	48=
RT9063-27GVN		SOT-23-3 (N)	43=
RT9063-28GV	2.8V	SOT-23-3	49=
RT9063-28GVN		SOT-23-3 (N)	44=
RT9063-33GV	3.3V	SOT-23-3	0K=
RT9063-33GVN		SOT-23-3 (N)	2X=
RT9063-33GX		SOT-89-3	0A=

Functional Pin Description

Pin No.			Pin Name	Pin Function
SOT-23-3	SOT-23-3 (N-Type)	SOT-89-3		
1	3	1	VCC	Supply Voltage Input.
2	2	3	VOUT	Output of the Regulator.
3	1	2	GND	Ground.

Function Block Diagram



Operation

The RT9063 is a high input voltage linear regulator specifically designed to minimize external components.

The minimum required output capacitance for stable operation is 1 μ F effective capacitance after consideration of the temperature and voltage coefficient of the capacitor.

Output Transistor

The RT9063 includes a built-in low on-resistance P-MOSFET output transistor for low dropout voltage applications.

Error Amplifier

The Error Amplifier compares the output feedback voltage from an internal feedback voltage divider to an internal reference voltage and controls the P-MOSFET's gate voltage to maintain output voltage regulation.

Current Limit

The RT9063 provides a current limit function to prevent damage during output over-load or shorted-circuit conditions. The output current is detected by an internal sensing transistor.

Over-Temperature Protection

The over-temperature protection function will turn off the P-MOSFET when the internal junction temperature exceeds 150°C (typ.) and the output current exceeds 30mA. Once the junction temperature cools down by approximately 20°C, the regulator will automatically resume operation.

Absolute Maximum Ratings (Note 1)

• VCC to GND -----	-0.3V to 7V
• VOUT to VCC -----	-7V to 0.3V
• VOUT to GND -----	-0.3V to 7V
• Power Dissipation, P_D @ $T_A = 25^\circ\text{C}$	
SOT-23-3 -----	0.41W
SOT-89-3 -----	0.59W
• Package Thermal Resistance (Note 2)	
SOT-23-3, θ_{JA} -----	243.3°C/W
SOT-89-3, θ_{JA} -----	167.7°C/W
• Lead Temperature (Soldering, 10 sec.) -----	260°C
• Junction Temperature -----	150°C
• Storage Temperature Range -----	-65°C to 150°C
• ESD Susceptibility (Note 3)	
HBM (Human Body Model) -----	2kV
MM (Machine Model) -----	200V

Recommended Operating Conditions (Note 4)

• Supply Input Voltage, VCC -----	2.5V to 6V
• Junction Temperature Range -----	-40°C to 125°C
• Ambient Temperature Range -----	-40°C to 85°C

Electrical Characteristics((VOUT + 1) < VCC < 6V, $T_A = 25^\circ\text{C}$, unless otherwise specified.)

Parameter	Symbol	Test Conditions	Min	Typ	Max	Unit
Output Voltage Range	VOUT		1.2	--	3.3	V
DC Output Accuracy		ILOAD = 1mA	-2	--	2	%
Dropout Voltage	VDrop	ILOAD = 0.2A, VOUT ≥ 3V	--	0.4	1.2	V
		ILOAD = 0.1A, VOUT < 3V	--	0.3	1	
Quiescent Current	IQ	No Load	--	1	3	µA
Line Regulation		ILOAD = 1mA, VOUT > 1.8V	--	0.6	1	%
		ILOAD = 1mA, VOUT ≤ 1.8V	--	0.6	1.3	
Load Regulation		10mA < ILOAD < 200mA, VOUT < 1.5V	--	1	1.4	
		10mA < ILOAD < 200mA, 1.5V ≤ VOUT < 2.5V	--	0.7	1.2	%
		10mA < ILOAD < 250mA, VOUT ≥ 2.5V	--	0.6	1	
Power Supply Rejection Ratio	PSRR	f = 100Hz, IOUT = 50mA	--	-70	--	dB
		f = 10kHz, IOUT = 50mA	--	-40	--	
Output Current Limit		VOUT = 0.5 × VOUT(Normal)	300	400	500	mA
OTP Threshold			--	150	--	°C
OTP Hysteresis			--	20	--	°C

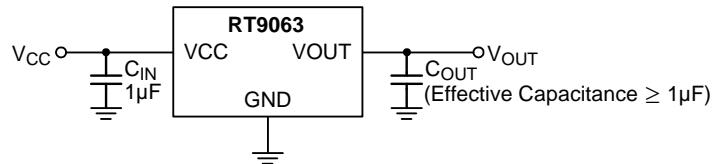
Note 1. Stresses beyond those listed "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions may affect device reliability.

Note 2. θ_{JA} is measured at $T_A = 25^\circ\text{C}$ on a high effective thermal conductivity four-layer test board per JEDEC 51-7.

Note 3. Devices are ESD sensitive. Handling precaution is recommended.

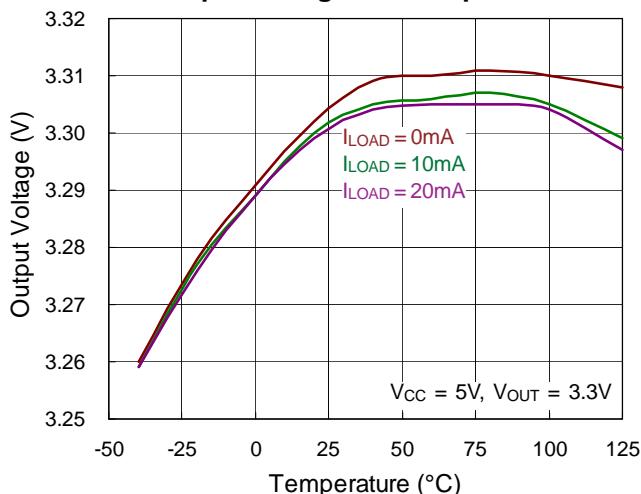
Note 4. The device is not guaranteed to function outside its operating conditions.

Typical Application Circuit

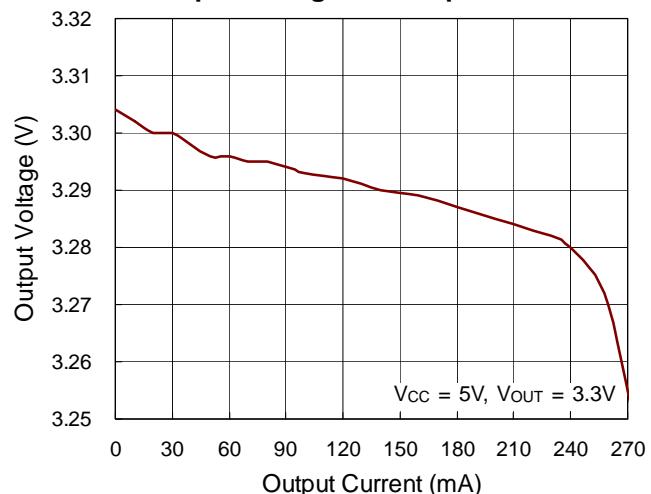


Typical Operating Characteristics

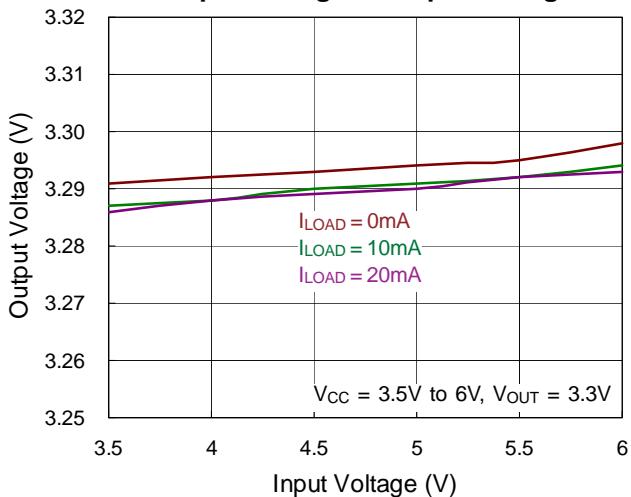
Output Voltage vs. Temperature



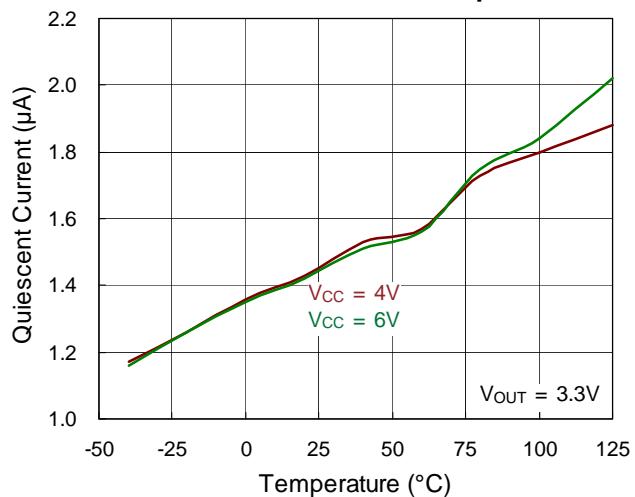
Output Voltage vs. Output Current



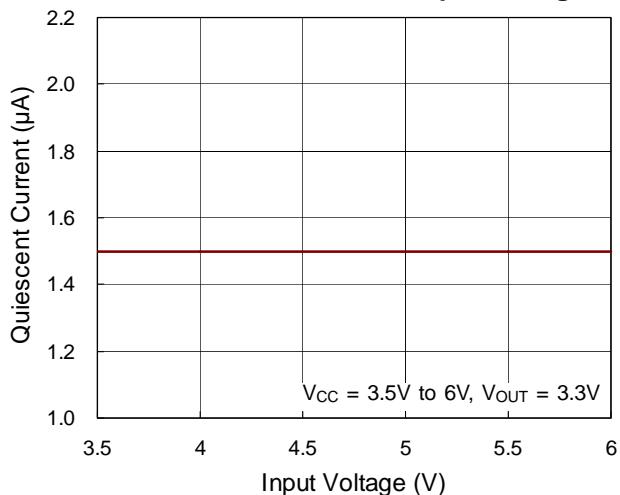
Output Voltage vs. Input Voltage



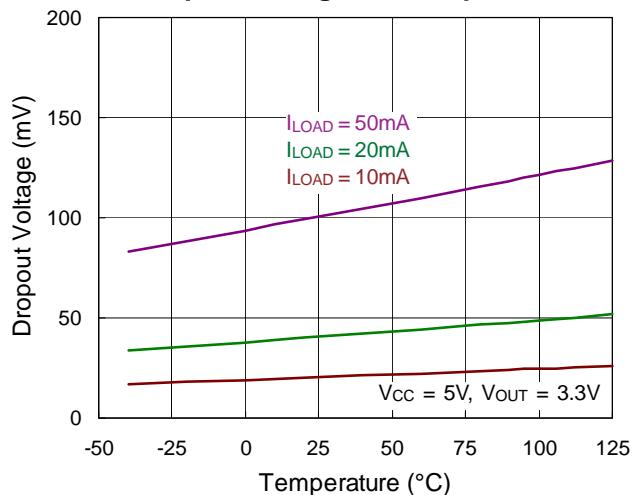
Quiescent Current vs. Temperature

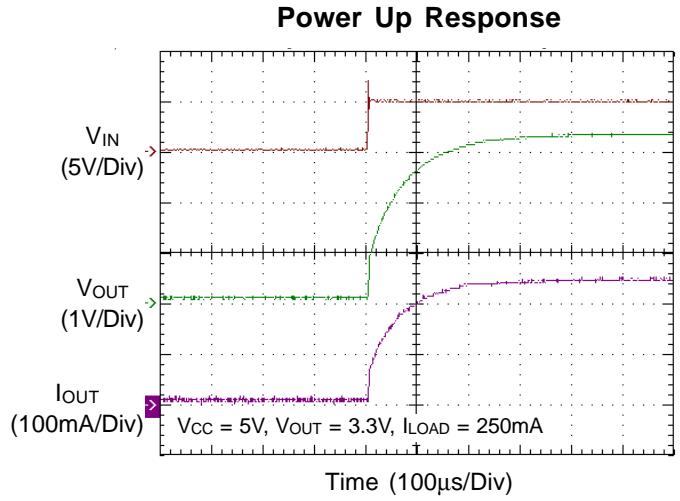
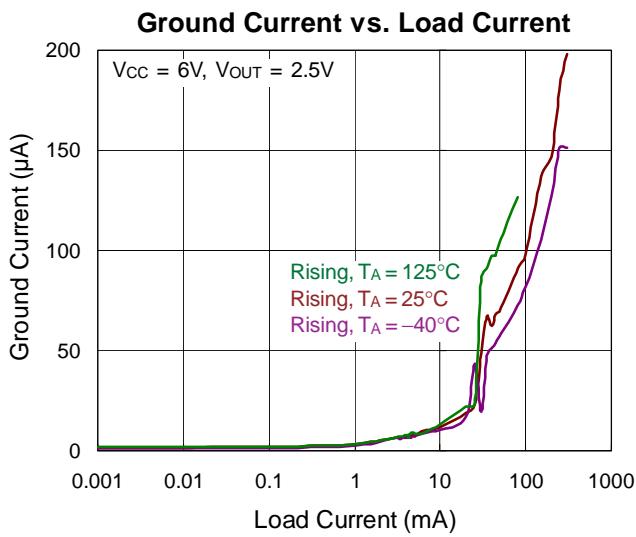
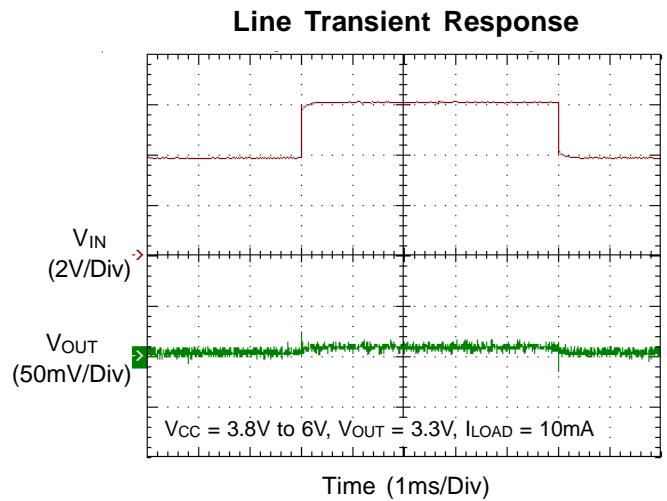
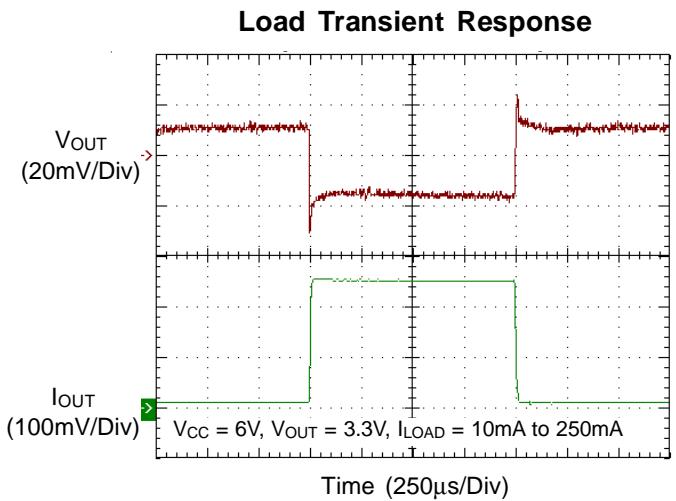
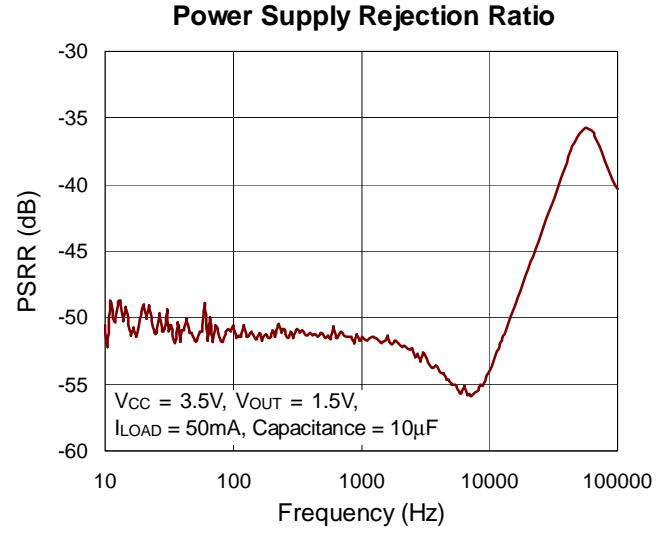
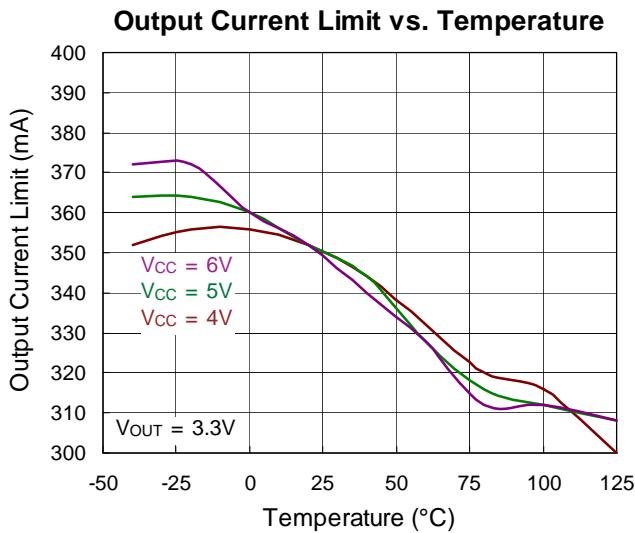


Quiescent Current vs. Input Voltage



Dropout Voltage vs. Temperature





Applications Information

Like any low dropout linear regulator, the RT9063's external input and output capacitors must be properly selected for stability and performance. Use a $1\mu\text{F}$ or larger input capacitor and place it close to the IC's VCC and GND pins.

Any output capacitor meeting the minimum $1\text{m}\Omega$ ESR (Equivalent Series Resistance) and effective capacitance larger than $1\mu\text{F}$ requirement may be used. Place the output capacitor close to the IC's VOUT and GND pins. Increasing capacitance and decreasing ESR can improve the circuit's PSRR and line transient response.

Thermal Considerations

For continuous operation, do not exceed absolute the maximum junction temperature. The maximum power dissipation depends on the thermal resistance of the IC package, PCB layout, rate of surrounding airflow, and the allowed difference between the junction and ambient temperatures. The maximum power dissipation can be calculated by the following formula :

$$P_{D(\text{MAX})} = (T_{J(\text{MAX})} - T_A) / \theta_{JA}$$

where $T_{J(\text{MAX})}$ is the maximum junction temperature, T_A is the ambient temperature, and θ_{JA} is the junction to ambient thermal resistance.

The recommended operating conditions specify a maximum junction temperature is 125°C . The junction to ambient thermal resistance, θ_{JA} , is layout dependent. On a standard JEDEC 51-7 four-layer thermal test board , the thermal resistance, θ_{JA} , of the SOT-23-3 package is $243.3^\circ\text{C}/\text{W}$. For the SOT-89-3 package, the θ_{JA} , is $167.7^\circ\text{C}/\text{W}$. The maximum power dissipation at $T_A = 25^\circ\text{C}$ can be calculated by the following formula :

$$P_{D(\text{MAX})} = (125^\circ\text{C} - 25^\circ\text{C}) / (243.3^\circ\text{C}/\text{W}) = 0.41\text{W} \text{ for SOT-23-3 package}$$

$$P_{D(\text{MAX})} = (125^\circ\text{C} - 25^\circ\text{C}) / (167.7^\circ\text{C}/\text{W}) = 0.59\text{W} \text{ for SOT-89-3 package}$$

For a fixed $T_{J(\text{MAX})}$ of 125°C , the maximum power dissipation depends on the operating ambient temperature and the package's thermal resistance, θ_{JA} . The derating curve in Figure 1 shows the effect of rising ambient temperature on the maximum recommended power dissipation.

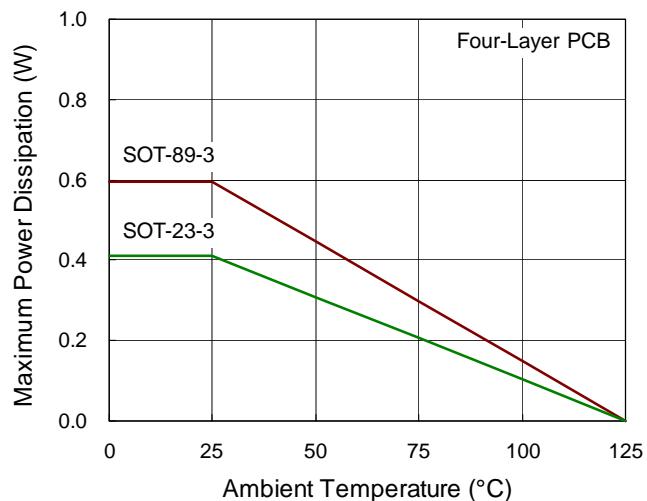
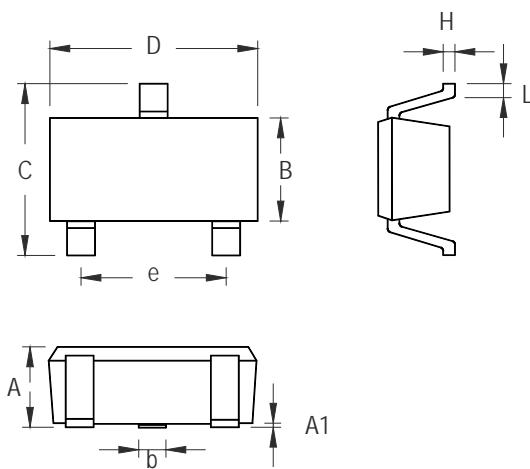


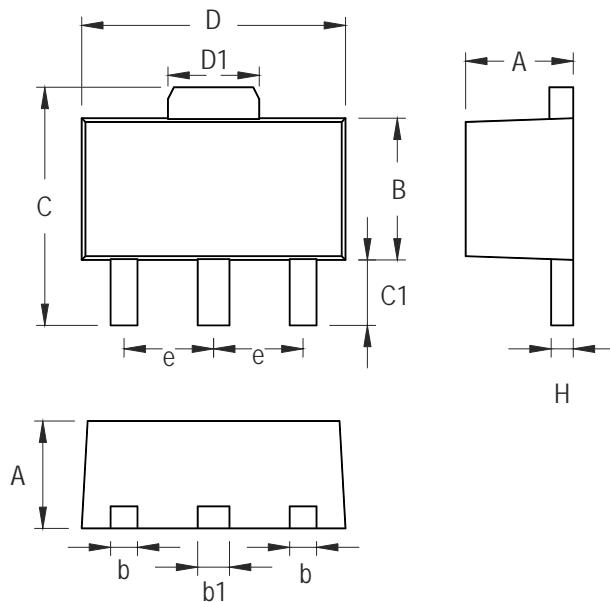
Figure 1. Derating Curve of Maximum Power Dissipation

Outline Dimension



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min	Max	Min	Max
A	0.889	1.295	0.035	0.051
A1	0.000	0.152	0.000	0.006
B	1.397	1.803	0.055	0.071
b	0.356	0.508	0.014	0.020
C	2.591	2.997	0.102	0.118
D	2.692	3.099	0.106	0.122
e	1.803	2.007	0.071	0.079
H	0.080	0.254	0.003	0.010
L	0.300	0.610	0.012	0.024

SOT-23-3 Surface Mount Package



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min	Max	Min	Max
A	1.397	1.600	0.055	0.063
b	0.356	0.483	0.014	0.019
B	2.388	2.591	0.094	0.102
b1	0.406	0.533	0.016	0.021
C	3.937	4.242	0.155	0.167
C1	0.787	1.194	0.031	0.047
D	4.394	4.597	0.173	0.181
D1	1.397	1.753	0.055	0.069
e	1.448	1.549	0.057	0.061
H	0.356	0.432	0.014	0.017

3-Lead SOT-89 Surface Mount Package

Richtek Technology Corporation

14F, No. 8, Tai Yuen 1st Street, Chupei City
Hsinchu, Taiwan, R.O.C.
Tel: (8863)5526789

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